**삼성전자 CE/IM부문 현장실습 참가 신청서**

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| **인****적****사****항** | **성명** |  | **영문성명** |  |
| **생년월일** |  | **희망직무** | SW개발/회로개발/기구개발 중 택1 |
| **핸드폰** |  | **e-mail** |  |

|  |  |  |  |  |  |  |  |
| --- | --- | --- | --- | --- | --- | --- | --- |
| **학****력****사****항** | **구 분** | **입학년월** | **졸업예정일** | **학교명** | **전공** | **재학 학기** | **학점** |
| **대학교** |  |  |  |  |  |  |

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|  |  | **일어** |  | **면제사유** |  |
|  |  | **중국어** |  | **군별** |  |
|  |  | **기타** |  | **보훈여부** |  |

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